

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Salman Akram

Serial No.: 10/797,504

Filed: March 10, 2004

For: METHODS RELATING TO SINGULATING SEMICONDUCTOR WAFERS AND WAFER SCALE ASSEMBLIES (as amended)

Confirmation No.: 3972

Examiner: H. Lee

Group Art Unit: 2823

Attorney Docket No.: 2269-5527US

(99-0440.00/US)

Notice of Allowance Mailed:

June 5, 2006

	NOTICE	OF	EXPRES	S MAII	LING
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 August 24, 2006

Person making Deposit: Wendy Neff

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the specification begin on page 3 of this paper;

Amendments to the claims are set forth in the listing of the claims that begins on page 7 of this paper; and

Remarks start at page 14 of this paper.